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ON Semiconductor®

#### FDN357N

## N-Channel Logic Level Enhancement Mode Field Effect Transistor

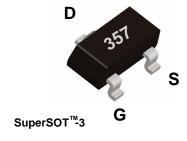
## **General Description**

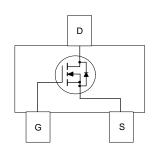
SuperSOTTM-3 N-Channel logic level enhancement mode power field effect transistors are produced using ON Semiconductor's proprietary, high cell density, DMOS technology. This very high density process is especially tailored to minimize on-state resistance. These devices are particularly suited for low voltage applications in notebook computers, portable phones, PCMCIA cards, and other battery powered circuits where fast switching, and low in-line power loss are needed in a very small outline surface mount package

#### **Features**

- Industry standard outline SOT-23 surface mount package using proprietary SuperSOT<sup>TM</sup>-3 design for superior thermal and electrical capabilities.
- High density cell design for extremely low R<sub>DS(ON)</sub>.
- Exceptional on-resistance and maximum DC current capability.







#### **Absolute Maximum Ratings** T<sub>A</sub> = 25°C unless other wise noted

Symbol	Parameter		FDN357N	Units
V <sub>DSS</sub>	Drain-Source Voltage		30	V
/ <sub>GSS</sub>	Gate-Source Voltage - Continuous		±20	V
I <sub>D</sub>	Drain/Output Current - Continuous		1.9	А
	- Pulsed		10	
P <sub>D</sub>	Maximum Power Dissipation	(Note 1a)	0.5	W
		(Note 1b)	0.46	
$T_J$ , $T_{STG}$	Operating and Storage Temperature Range		-55 to 150	°C
THERMA	L CHARACTERISTICS			
$R_{\theta JA}$	Thermal Resistance, Junction-to-Ambient (Note 1a)		250	°C/W
R <sub>euc</sub>	Thermal Resistance, Junction-to-Case (Note 1)		75	°C/W

Symbol	Parameter	Conditions		Min	Тур	Max	Units
OFF CHAR	ACTERISTICS						_
BV <sub>DSS</sub>	Drain-Source Breakdown Voltage	$V_{GS} = 0 \text{ V}, \ I_{D} = 250 \ \mu\text{A}$		30			V
$\Delta BV_{DSS}/\Delta T_{J}$	Breakdown Voltage Temp. Coefficient	I <sub>D</sub> = 250 μA, Referenced to 25 °C			36		mV/°C
I <sub>DSS</sub>	Zero Gate Voltage Drain Current	$V_{DS} = 24 \text{ V}, \ V_{GS} = 0 \text{ V}$				1	μA
			$T_J = 55^{\circ}C$			10	μA
I <sub>GSSF</sub>	Gate - Body Leakage, Forward	$V_{GS} = 20 \text{ V}, V_{DS} = 0 \text{ V}$	•			100	nA
I <sub>GSSR</sub>	Gate - Body Leakage, Reverse	$V_{GS} = -20 \text{ V}, V_{DS} = 0 \text{ V}$				-100	nA
ON CHARA	CTERISTICS (Note)			•		•	
$V_{GS(th)}$	Gate Threshold Voltage	$V_{DS} = V_{GS}, I_{D} = 250 \mu\text{A}$		1	1.6	2	V
$\Delta V_{GS(th)}/\Delta T_{J}$	Gate Threshold Voltage Temp. Coefficient	I <sub>D</sub> = 250 μA, Referenced to 25 °C			-3.6		mV/°C
R <sub>DS(ON)</sub>	Static Drain-Source On-Resistance	$V_{GS} = 4.5 \text{ V}, I_D = 1.9 \text{ A}$			0.081	0.09	Ω
()			T <sub>.1</sub> =125°C		0.11	0.14	1
		$V_{GS} = 10 \text{ V}, I_D = 2.2 \text{ A}$			0.053	0.06	1
I <sub>D(ON)</sub>	On-State Drain Current	$V_{GS} = 4.5 \text{ V}, \ V_{DS} = 5 \text{ V}$		5			Α
g <sub>FS</sub>	Forward Transconductance	$V_{DS} = 5 \text{ V}, I_{D} = 1.9 \text{ A}$			5		S
DYNAMIC C	HARACTERISTICS			•		•	
C <sub>iss</sub>	Input Capacitance	$V_{DS} = 10 \text{ V}, V_{GS} = 0 \text{ V},$ $f = 1.0 \text{ MHz}$			235		pF
C <sub>oss</sub>	Output Capacitance				145		pF
C <sub>rss</sub>	Reverse Transfer Capacitance				50		pF
SWITCHING	CHARACTERISTICS (Note)						
t <sub>D(on)</sub>	Turn - On Delay Time	$V_{DD} = 10 \text{ V}, \ I_{D} = 1 \text{ A},$ $V_{GS} = 10 \text{ V}, \ R_{GEN} = 6 \Omega$			5	10	ns
t,	Turn - On Rise Time				12	22	ns
$t_{D(off)}$	Turn - Off Delay Time				12	22	ns
t,	Turn - Off Fall Time				3	8	ns
$Q_g$	Total Gate Charge	$V_{DS} = 10 \text{ V}, I_{D} = 1.9 \text{ A},$ $V_{GS} = 5 \text{ V}$			4.2	5.9	nC
$Q_{gs}$	Gate-Source Charge				1.3		nC
$Q_{gd}$	Gate-Drain Charge				1.7		nC
DRAIN-SOL	IRCE DIODE CHARACTERISTICS AND M	AXIMUM RATINGS		1	1		
I <sub>s</sub>	Maximum Continuous Drain-Source Diode Fo	rward Current				0.42	Α
$V_{SD}$	Drain-Source Diode Forward Voltage	$V_{GS} = 0 \text{ V}, \ I_{S} = 0.42 \text{ A} \ \text{(Note)}$			0.71	1.2	V

Note

Typical  $\rm R_{\rm B,A}$  using the board layouts shown below on 4.5"x5" FR-4 PCB in a still air environment :



a. 250°C/W when mounted on a 0.02 in² pad of 2oz Cu.



b. 270°C/W when mounted on a 0.001 in² pad of 2oz Cu.

Scale 1 : 1 on letter size paper

2. Pulse Test: Pulse Width ≤ 300µs, Duty Cycle ≤ 2.0%.

<sup>1.</sup>  $R_{g,u}$  is the sum of the junction-to-case and case-to-ambient thermal resistance where the case thermal reference is defined as the solder mounting surface of the drain pins.  $R_{g,c}$  is guaranteed by design while  $R_{g,c}$  is determined by the user's board design.

## **Typical Electrical Characteristics**

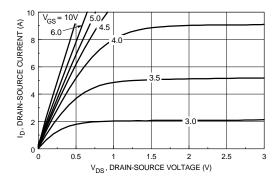
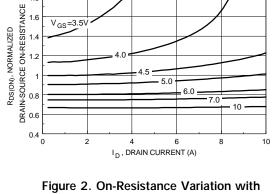


Figure 1. On-Region Characteristics.



**Drain Current and Gate** 

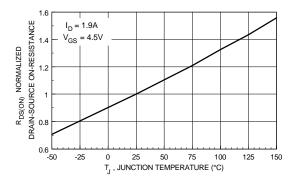


Figure 3. On-Resistance Variation with Temperature.

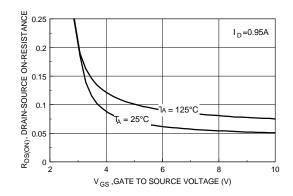


Figure 4. On-Resistance Variation with Gate-to-Source Voltage.

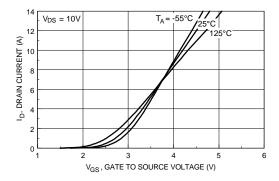


Figure 5. Transfer Characteristics.

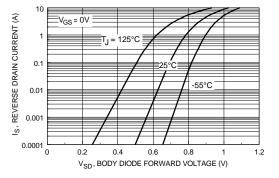


Figure 6. Body Diode Forward Voltage Variation with Source Current and Temperature.

## **Typical Electrical And Thermal Characteristics**

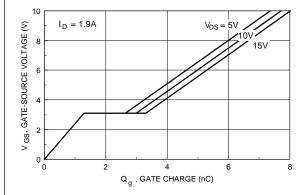


Figure 7. Gate Charge Characteristics.

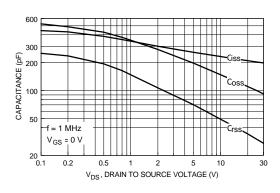


Figure 8. Capacitance Characteristics.

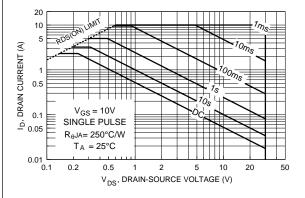


Figure 9. Maximum Safe Operating Area.

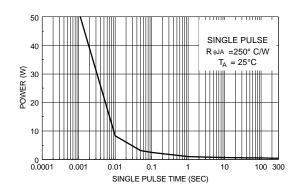


Figure 10. Single Pulse Maximum Power Dissipation.

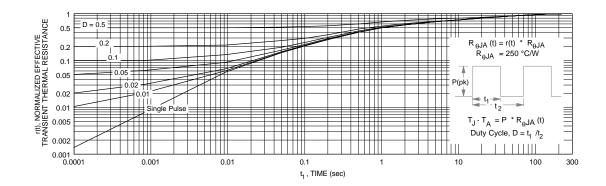


Figure 11. Transient Thermal Response Curve.

Note: Thermal characterization performed using the conditions described in note 1a. Transient thermal response will change depending on the circuit board design.

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